

East 8USPB, USPT, WPID, JPO

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	416712	resist or photoresist or mask or photomask	US-PGPUB; USPAT	OR	OFF	2005/04/11 20:48
L2	2396754	etch\$ or patern\$ or remov\$	US-PGPUB; USPAT	OR	OFF	2005/04/11 20:49
L3	258675	grind\$ or bevel\$	US-PGPUB; USPAT	OR	OFF	2005/04/11 20:50
L4	169317	wafer	US-PGPUB; USPAT	OR	OFF	2005/04/11 20:49
L5	886366	laminat\$ or bond\$	US-PGPUB; USPAT	OR	OFF	2005/04/11 20:50
L6	15735	1 with 2 with 4	US-PGPUB; USPAT	OR	OFF	2005/04/11 20:13
L7	17717	4 with 5	US-PGPUB; USPAT	OR	OFF	2005/04/11 20:14
L8	231325	lap\$ or abrad\$	US-PGPUB; USPAT	OR	OFF	2005/04/11 20:50
L9	6738	4 with (3 or 8)	US-PGPUB; USPAT	OR	OFF	2005/04/11 20:14
L10	29	6 same 7 same 9	US-PGPUB; USPAT	OR	OFF	2005/04/11 20:19
L11	116	1 same 2 same (3 or 8) same 4 same 5	US-PGPUB; USPAT	OR	OFF	2005/04/11 20:19
L12	87	11 not 10	US-PGPUB; USPAT	OR	OFF	2005/04/11 20:19
L13	317646	resist or photoresist or mask or photomask	JPO; DERWENT	OR	OFF	2005/04/11 20:21
L14	1666011	etch\$ or patern\$ or remov\$	JPO; DERWENT	OR	OFF	2005/04/11 20:21
L15	163208	grind\$ or bevel\$	JPO; DERWENT	OR	OFF	2005/04/11 20:21
L16	184465	wafer	JPO; DERWENT	OR	OFF	2005/04/11 20:21
L17	969009	laminat\$ or bond\$	JPO; DERWENT	OR	OFF	2005/04/11 20:22
L18	93332	lap\$ or abrad\$	JPO; DERWENT	OR	OFF	2005/04/11 20:22
L19	30	13 and 14 and 16 and 17 and (18 or 15)	JPO; DERWENT	OR	OFF	2005/04/11 20:27
L20	17	12 and soi	US-PGPUB; USPAT	OR	OFF	2005/04/11 20:27
L21	70	12 not 20	US-PGPUB; USPAT	OR	OFF	2005/04/11 20:37
L22	17	12 not 21	US-PGPUB; USPAT	OR	OFF	2005/04/11 20:30

L23	23	11 and soi	US-PGPUB; USPAT	OR	OFF	2005/04/11 20:30
L24	6	23 not 22	US-PGPUB; USPAT	OR	OFF	2005/04/11 20:30
L25	110	11 not 24	US-PGPUB; USPAT	OR	OFF	2005/04/11 20:30
L26	6	11 not 25	US-PGPUB; USPAT	OR	OFF	2005/04/11 20:30
L27	18	11 same bevel\$	US-PGPUB; USPAT	OR	OFF	2005/04/11 20:37
L28	15	21 and 27	US-PGPUB; USPAT	OR	OFF	2005/04/11 20:41
L29	55	21 not 28	US-PGPUB; USPAT	OR	OFF	2005/04/11 20:42
L30	3	27 not 28	US-PGPUB; USPAT	OR	OFF	2005/04/11 20:42
L31	94858	(resist or photoresist or mask or photomask).clm.	US-PGPUB; USPAT	OR	OFF	2005/04/11 20:48
L32	647874	(etch\$ or patern\$ or remov\$).clm.	US-PGPUB; USPAT	OR	OFF	2005/04/11 20:49
L33	42565	wafer.clm.	US-PGPUB; USPAT	OR	ON	2005/04/11 20:49
L34	251821	(laminat\$ or bond\$).clm.	US-PGPUB; USPAT	OR	OFF	2005/04/11 20:50
L35	47299	(grind\$ or bevel\$).clm.	US-PGPUB; USPAT	OR	OFF	2005/04/11 20:50
L36	22880	(lap\$ or abrad\$).clm.	US-PGPUB; USPAT	OR	OFF	2005/04/11 20:50
L37	63	31 and 32 and 33 and 34 and (35 or 36)	US-PGPUB; USPAT	OR	OFF	2005/04/11 20:51
L38	51	37 not 11	US-PGPUB; USPAT	OR	OFF	2005/04/11 20:51
L39	0	38 and bevel\$.clm.	US-PGPUB; USPAT	OR	OFF	2005/04/11 20:51